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Ram N. Tinnirella
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#6A
2/27/02
MW

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In the Application of)
RICHARD R. HENGST)
Serial No.: 09/884,720)
Filed: June 19, 2001)
For: APPARATUS AND METHOD OF)
MAKING A SLIP FREE WAFER BOAT)

Group Art Unit: 1763

Examiner: Ram N. Kackar

(Our File No. 6096-01)

Box NON-FEE AMENDMENT
ASSISTANT COMMISSIONER FOR PATENTS
Washington, D.C. 20231

RESPONSE TO OFFICE ACTION

Dear Sir:

This is in response to the Office Action dated October 2, 2002 issued in the above-identified application. The time for response extends until January 2, 2003.

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